



EXPRESS MAIL NO. EV207709130US

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Reishi Naka et al.  
Application No. : 10/004,538  
Filed : October 23, 2001  
For : HEAT CONDUCTIVITY MEASUREMENT METHOD AND  
INSTRUMENT AND METHOD OF PRODUCING A HEAT  
INSULATING MATERIAL

Examiner : Gail Kaplan Verbitsky  
Art Unit : 2859  
Docket No. : 980039.409  
Date : March 6, 2003

Commissioner for Patents  
Washington, DC 20231

AMENDMENT

Commissioner for Patents:

In response to the Office Action dated November 6, 2002, please extend the period of time for response one month, to expire on March 6, 2003. Enclosed are a Petition for an Extension of Time and the requisite fee. Please amend the application as follows:

In the Title:

Please amend the title to read as follows:

THERMAL CONDUCTIVITY MEASUREMENT METHOD AND INSTRUMENT  
AND METHOD OF PRODUCING A HEAT INSULATING MATERIAL

In the Claims:

Please amend claims 1-7 to read as follows:

(All pending claims have been provided for the convenience of the Examiner).

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